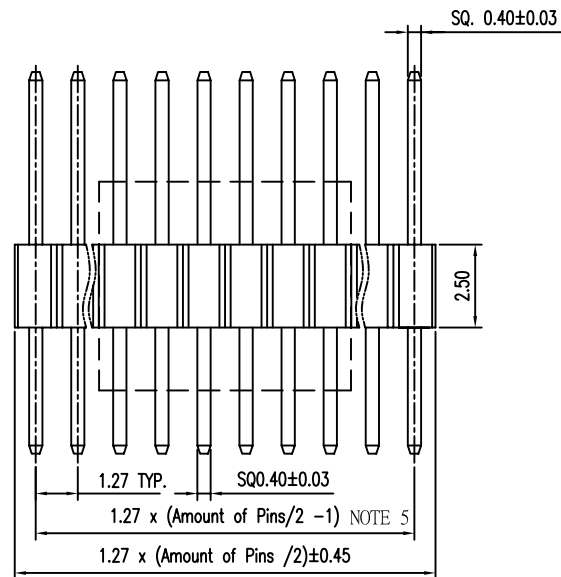




NOTE:

1. MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0,BLACK
TERMINAL: COPPER ALLOY , SQ=0.40±0.03MM
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260°C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
5. THE TOLERANCE OF THIS DIMENSION

2-60 PINS	± 0.20
62-98 PINS	± 0.30

6. PRODUCT NUMBERING:

20021122 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

1:GOLD FLASH ALL OVER

4:0.25um(10U")GOLD AT CONTACT

8:0.76um(30U")GOLD AT CONTACT

9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

T: TUBE

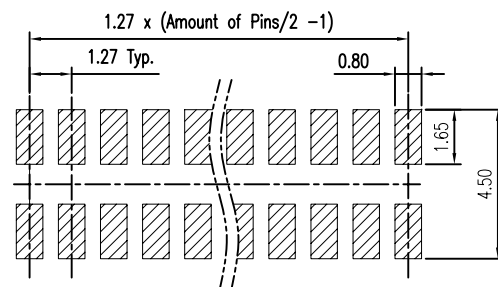
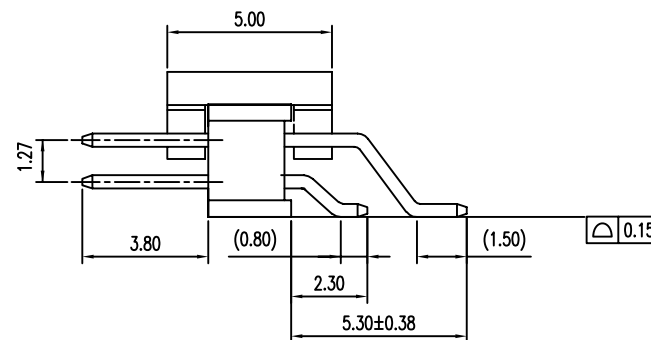
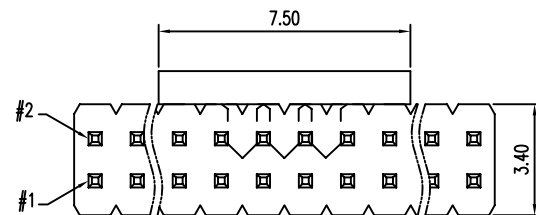
D: TUBE + CAP

C: REEL + CAP

PIN COUNT

06,08,10,...., 98

(8 -98 EVERY EVEN PIN)



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

mat'l. code				surface		tolerance		projection	product family		
				ISO1302	ISO1101	ISO406	ISO406		MINITEK		
ltr	ecn no	dr	date	tolerances unless otherwise specified				MM	title		
A	T09-1117	S.LIN	09/15/09	angles	0.X±0.38	0.XX±0.25	0.XXX±0.10		1.27X1.27MM BTB HEADER		
B	T09-1155	S.LIN	12/03/09	0°±2°	0.XX±0.25	0.XXX±0.10	0.XXX±0.10	scale 5:1	UNSHROUDED SMT		
C	T10-0014	S.LIN	01/28/10	0°±2°	0.XX±0.25	0.XXX±0.10	0.XXX±0.10	scale 5:1	dwg no		
D	T11-0029	S.LIN	06/14/11	dr	STERLING LIN	09/15/09	09/15/09	FCI	sheet. 1 of 1		
E	ELX-N-010358	ZK	01/16/12	engr	STERLING LIN	09/15/09	09/15/09		20021122		
F	ELX-N-010619	ZK	03/12/12	chr	GRAY HSIEH	09/15/09	09/15/09		A4		
G	ELX-N-16465	TIM	12/06/13	appd	JOSEPH	09/15/09	09/15/09		type Product Customer Drawing		
sheet	revision	G									
index	sheet	1									